MA26V09

Silicon epitaxial planar type

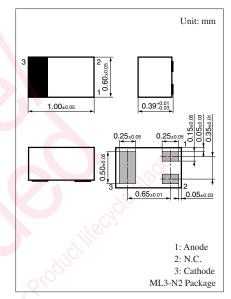
For VCO

Features

- \bullet Good linearity and large capacitance-ratio in C_D V_R relation
- \bullet Small series resistance $r_{\rm D}$

Absolute Maximum Ratings $T_a = 25^{\circ}C$

| Parameter | Symbol | Rating | Unit | |
|----------------------|------------------|-------------|------|--|
| Reverse voltage | V _R | 6 | v | |
| Junction temperature | Tj | 125 | °C | |
| Storage temperature | T _{stg} | -55 to +125 | °C | |



Marking Symbol: 2S

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | | Symbol | Conditions | Min | Тур | Max | Unit |
|---------------------|----|------------------------------------|--------------------------|------|------|------|------|
| Reverse current | | IR | $V_R = 5 V$ | 00 | cOr. | 10 | nA |
| Diode capacitance | | C _{D1V} | $V_R = 1 V, f = 1 MHz$ | 14.9 | 0- | 16.4 | pF |
| | | C _{D3V} | $V_R = 3 V, f = 1 MHz$ | 8.4 | | 9.2 | |
| Capacitance ratio | | C _{D1V} /C _{D3V} | | 1.69 | | 1.87 | — |
| Series resistance * | 20 | r _D | $V_R = 3 V, f = 470 MHz$ | | | 0.35 | Ω |

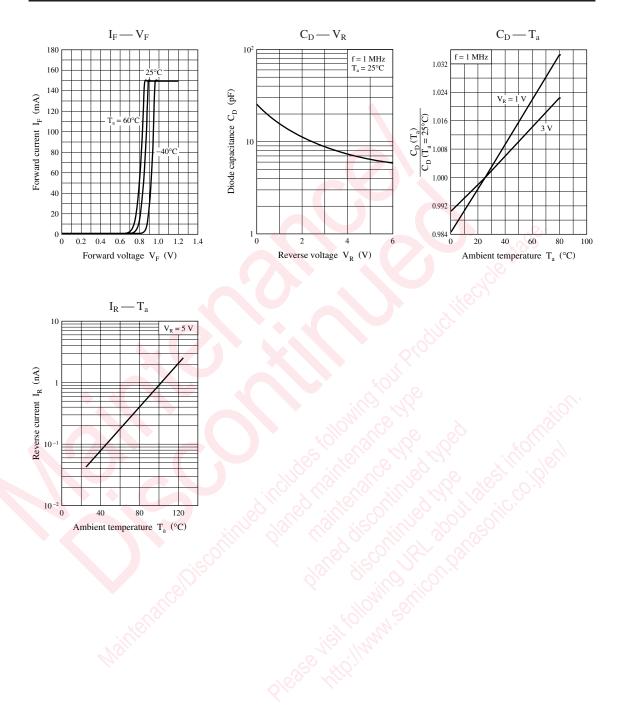
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 470 MHz.

3. *: Measuring instrument; YHP MODEL 4191A RF IMPEDANCE ANALYZER

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